

3 providing a substrate having a length extending in  
4 the machine direction, a width extending in the machine  
5 cross direction, and a substrate surface,

6 combining said substrate with a pressure-sensitive  
7 adhesive layer, said pressure-sensitive adhesive layer  
8 having a length extending in the machine direction, a  
9 width extending in the machine cross direction, and an  
10 exposed adhesive surface remote of said substrate  
11 surface,

12 applying adhesive-inhibiting masking to said exposed  
13 adhesive surface of said pressure-sensitive adhesive  
14 layer along a continuous machine-direction line or zone  
15 extending across a portion of said width of said exposed  
16 adhesive surface to form a nonadhesive line or zone and  
17 an adjacent adhesive surface line or zone substantially  
18 free of masking, and

19 winding said substrate and pattern coated adhesive  
20 layer into a roll to form said roll stock.

1 13. (new) The method of claim 12, wherein said  
2 adhesive-inhibiting masking is applied at a plurality of  
3 spaced locations along the width of said exposed adhesive  
4 surface to form a corresponding plurality of nonadhesive  
5 lines or zones with adjacent adhesive lines or zones.

1        14. (new) The method of claim 13, wherein said  
2 substrate also includes side edges extending in the  
3 machine direction, and said roll stock has an edge  
4 thickness substantially equal to the average thickness of  
5 the roll stock across its width.

15. (new) The method of claim 13, wherein said  
substrate also includes side edges extending in the  
machine direction, and said adhesive-inhibiting masking  
is also applied in a continuous line or zone at each of  
said side edges of said substrate to provide pick-free  
edges.

16. (new) The method of claim 12, wherein said  
adhesive layer has a width substantially equal to the  
width of said substrate.

17. (new) The method of claim 16, wherein said  
adhesive-inhibiting masking is applied at a plurality of  
spaced locations along the width of said exposed adhesive  
surface to form a corresponding plurality of nonadhesive  
lines or zones with adjacent adhesive lines or zones.

18. (new) The method of claim 12, including the  
further step of subsequently applying additional  
adhesive-inhibiting masking to said exposed adhesive

4 surface of said pressure-sensitive adhesive layer along a  
5 second continuous machine-direction line or zone  
6 extending across another portion of said width of said  
7 exposed adhesive surface to form a second nonadhesive  
8 line or zone spaced from said first mentioned nonadhesive  
9 line or zone.

all  
1 19. (new) The method of claim 18, wherein said  
2 second nonadhesive line or zone is sized and positioned  
3 in a pattern different from that of said first mentioned  
4 nonadhesive line or zone.

1 20. (new) A method of making an article having  
2 adhesive and nonadhesive surface lines or zones  
3 comprising the steps of:

4 providing a substrate including a substrate surface,  
5 combining said substrate with a pressure-sensitive  
6 adhesive layer, said pressure-sensitive adhesive layer  
7 having a width, a length and an exposed adhesive surface  
8 remote of said substrate surface,

9 applying adhesive-inhibiting masking in a continuous  
10 machine-direction line or zone along said exposed  
11 adhesive surface of said pressure-sensitive adhesive  
12 layer to form said nonadhesive surface line or zone, said  
13 nonadhesive line or zone having a width less than said  
14 adhesive layer width whereby an adjacent portion of said

15 exposed adhesive surface of said pressure-sensitive  
16 adhesive layer forms said adhesive line or zone, and  
17 incorporating said pressure-sensitive adhesive layer  
18 into said article to provide said article with said  
19 adhesive and nonadhesive surface lines or zones.

all 1 21. (new) The method of claim 20, wherein said step  
2 of incorporating said pressure-sensitive adhesive layer  
3 into said article includes incorporating said substrate  
4 and said pressure-sensitive adhesive layer in said  
5 article.

1 22. (new) The method of claim 20, wherein said step  
2 of incorporating said pressure-sensitive adhesive layer  
3 into said article includes separating said pressure-  
4 sensitive adhesive layer from said substrate and  
5 incorporating said pressure-sensitive adhesive layer in  
6 said article.

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